

AMPMODU | AMPMODU Headers

TE Internal #: 6-102570-1

PCB Mount Header, Right Angle, Wire-to-Board, 26 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, AMPMODU Headers

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Connector System: Wire-to-Board

Number of Positions: 26

Number of Rows: 2

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Orientation: Right Angle

Features

Product Type Features

| Connector System | Wire-to-Board |
|-----------------------------------|-----------------------|
| Header Type | Fully Shrouded |
| Connector & Contact Terminates To | Printed Circuit Board |
| PCB Connector Assembly Type | PCB Mount Header |

Configuration Features

| Connector Contact Load Condition | Fully Loaded |
|----------------------------------|--------------|
| Number of Positions | 26 |
| Number of Rows | 2 |
| PCB Mount Orientation | Right Angle |

Electrical Characteristics

| Insulation Resistance | 5000 ΜΩ |
|---------------------------------------|----------|
| Dielectric Withstanding Voltage (Max) | 750 Vrms |

Body Features

| Connector Profile | Standard |
|-----------------------|----------|
| Primary Product Color | Black |

Contact Features

| Mating Square Post Dimension | .64 mm[.025 in] |
|---|-------------------------------|
| PCB Contact Termination Area Plating Material Thickness | 2.54 – 5.08 μm[100 – 200 μin] |



| Contact Mating Area Plating Material Thickness | .381 μm[15 μin] |
|--|----------------------------|
| Contact Shape & Form | Square |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| Contact Mating Area Plating Material | Gold |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| Termination Features | |
| Square Termination Post & Tail Dimension | .64 mm[.025 in] |
| Termination Post & Tail Length | 3.43 mm[.135 in] |
| Termination Method to Printed Circuit Board | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Alignment Type | Polarization |
| Mating Retention | With |
| Mating Retention Type | Detent Window |
| Connector Mounting Type | Board Mount |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| Housing Features | |
| Housing Material | Thermoplastic |
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Dimensions | |
| PCB Thickness (Recommended) | 1.4 mm[.055 in] |
| Row-to-Row Spacing | 2.54 mm[.1 in] |
| Usage Conditions | |
| Housing Temperature Rating | Standard |
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
| Operation/Application | |
| Solder Process Feature | Board Standoff |
| Circuit Application | Signal |



Industry Standards

| Agency/Standard | CSA |
|--|-----------------------|
| Approved Standards | CSA LE7189, UL E28476 |
| UL Flammability Rating | UL 94V-0 |
| | |
| Packaging Features | |
| Packaging Features Packaging Quantity | 112 |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content | BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources. |
| Solder Process Capability | Wave solder capable to 240°C |

Product Compliance Disclaimer

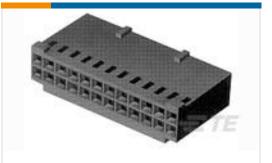
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts





TE Part # 2-87456-1
26 MODIV HSG COMP DR .100CL



TE Part # 1-87977-1
26 MODIV HSG DR MRKD .100 POL



TE Part # 86177-4
26 MODIV HSG COMP DR .100CL

Also in the Series | AMPMODU Headers



PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Headers & Receptacles(4875)



PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(65)

Customers Also Bought



TE Part #5499141-4 A/L UNIV HDR 20P RA LG LAT



TE Part #6-6609107-8 PS0SXDS6B=C1175



TE Part #5-102202-3
06 MODII HDR SRST SHRD LF

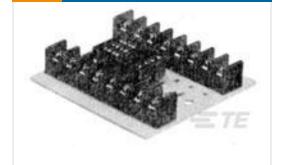




TE Part #350825-1 03P UMNL HDR ASSY PC 94VO



TE Part #1648151-1 241-27-01100



TE Part #4-1393143-4 27E461=SOCKETS







Documents

Product Drawings

26 MODII HDR DRRA SHRD LF

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_6-102570-1_H.3d_igs.zip

English

Customer View Model

ENG_CVM_6-102570-1_H.3d_stp.zip

English

Customer View Model

ENG_CVM_6-102570-1_H.2d_dxf.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English